

Microchip**Filter specification****TFS 130B****1/5****Measurement condition**

Ambient temperature:	23	°C
Input power level:	0	dBm
Terminating impedance: *		
Input:	470 Ω	-12,9 pF
Output:	470 Ω	-12,9 pF

Characteristics

Remark:

The reference level for the relative attenuation a_{rel} of the TFS 130B is the minimum of the pass band attenuation a_{min} . The minimum of the pass band attenuation a_{min} is defined as the insertion loss a_e . The centre frequency f_c is the arithmetic mean value of the upper and lower frequencies at the 3 dB filter attenuation level relative to the insertion loss a_e . The nominal frequency f_N is fixed at 130,38 MHz without any tolerance. The given values for both the relative attenuation a_{rel} and the group delay ripple have to be achieved at the frequencies given below even if the centre frequency f_c is shifted due to the temperature coefficient of frequency TC_f in the operating temperature range and due to a production tolerance for the centre frequency f_c .

D a t a		typ. value		tolerance / limit		
Insertion loss (reference level)	a_e	6,6	dB	max.	8,0	dB
Nominal frequency	f_N				130,38	MHz
Centre frequency at ambient temperature	f_c	130,38	MHz		-	
Passband	PB	-		f_N	\pm	0,665 MHz
Bandwidth at ambient temperature	BW					
1 dB		2,0	MHz			
3 dB		3,1	MHz			
20 dB		5,5	MHz			
40 dB		6,4	MHz			
Relative attenuation	a_{rel}					
f_N ... $f_N \pm$	0,665 MHz	-		max.	1	dB
$f_N - 20,0$ MHz ... $f_N -$	5,75 MHz	45	dB	min.	40	dB
$f_N + 5,75$ MHz ... $f_N +$	9,87 MHz	45	dB	min.	40	dB
$f_N + 9,87$ MHz ... $f_N +$	10,87 MHz	41	dB	min.	38	dB
$f_N + 10,87$ MHz ... $f_N +$	20,0 MHz	46	dB	min.	40	dB
$f_N \pm 20,0$ MHz ... $f_N \pm$	100,0 MHz	55	dB			
Group delay	mean value in PB	0,77	μ s		0,77 \pm 0,03	μ s
Group delay ripple within PB	p-p	50,0	ns		-	
Deviation from linear phase within PB (p-p)		3°			-	
Deviation from linear phase within PB (r.m.s.)		0,7°		max.	2,5°	
Triple transit attenuation compared to main signal		50	dB		-	
Crosstalk		50	dB		-	
VSWR		1,5 : 1		max.	2 : 1	
Operating temperature range	OTR	-			- 45 °C ... + 85 °C	
Storage temperature range		-			- 40 °C ... + 85 °C	
Temperature coefficient of frequency	TC_f **	- 19	ppm/K			

*) The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

**) $\Delta f_c(\text{Hz}) = TC_f(\text{ppm/K}) \times (T - T_A) \times f_{cat}(\text{MHz})$

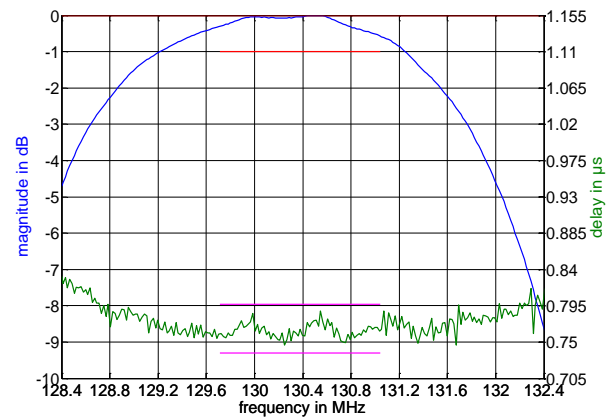
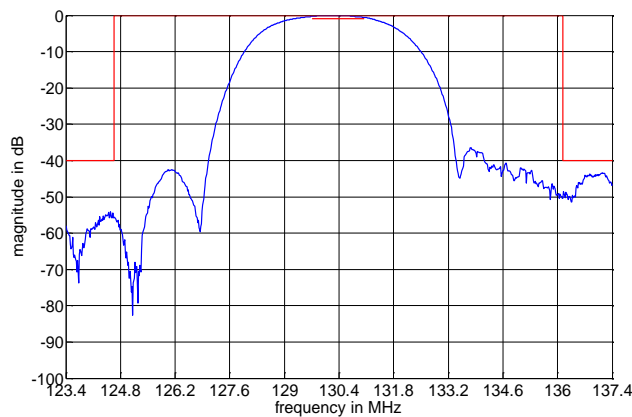
Generated:

Checked / Approved:

Microchip Frequency Technology GmbH
Potsdamer Straße 18
D 14 513 TELTOW / Germany
Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30

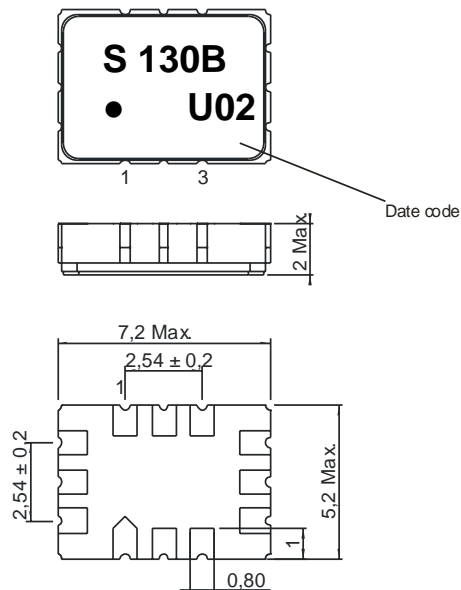
Microchip Frequency Technology GmbH reserves the right to make changes to the product(s) and/or information contained herein without notice. No liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such product(s) or information.

Filter characteristic



Construction and pin connection

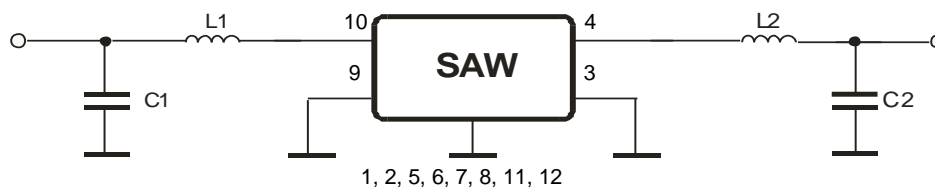
(All dimensions in mm)



1	Ground
2	Ground
3	Output RF Return
4	Output
5	Ground
6	Ground
7	Ground
8	Ground
9	Input RF Return
10	Input
11	Ground
12	Ground

Date code: Year + week
W 2008
X 2009
A 2010
...

50 Ω Test circuit



Microchip Frequency Technology GmbH
Potsdamer Straße 18
D 14 513 TELTOW / Germany
Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30

Microchip Frequency Technology GmbH reserves the right to make changes to the product(s) and/or information contained herein without notice. No liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such product(s) or information.

Microchip**Filter specification****TFS 130B****3/5****Stability characteristics, reliability**

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 1 ms, half sine wave, 3 shocks each plane;
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0,35 mm or 5 g respectively, 1 octave per min, 10 cycles per plan, 3 plans;
DIN IEC 68 T2 - 6
3. Change of temperature: -55 °C to 125°C / 30 min. each / 10 cycles
DIN IEC 68 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: twice max.;
for temperature conditions refer to the attached "Air reflow temperature conditions" on page 4;

This filter is RoHS compliant (2002/95/EG, 2005/618/EG)

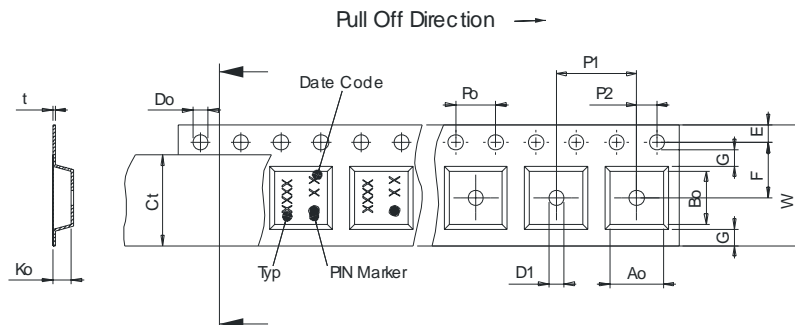
Packing

Tape & Reel: IEC 286 – 3, with exeption of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

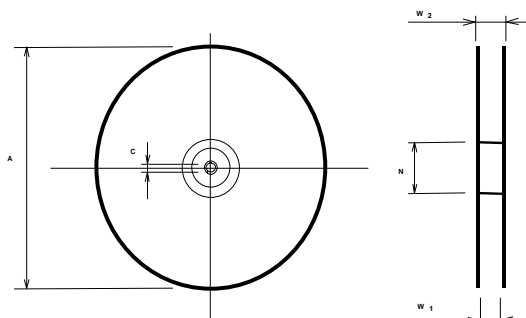
max. pieces of filters peer reel:	3000
reel of empty components at start:	min. 300 mm
reel of empty components at start including leader:	min. 500 mm
trailer:	min. 300 mm

Tape (all dimensions in mm)

W	: 16,00 ± 0,3
Po	: 4,00 ± 0,1
Do	: 1,50 +0,1/-0
E	: 1,75 ± 0,1
F	: 7,50 ± 0,1
G(min)	: 0,60
P2	: 2,00 ± 0,1
P1	: 8,00 ± 0,1
D1(min)	: 1,50
Ao	: 5,50 ± 0,1
Bo	: 7,50 ± 0,1
Ct	: 13,5 ± 0,1

**Reel (all dimensions in mm)**

A	: 330
W1	: 16,4 +2/-0
W2(max)	: 22,4
N(min)	: 50
C	: 13,0 +0,5/-0,2



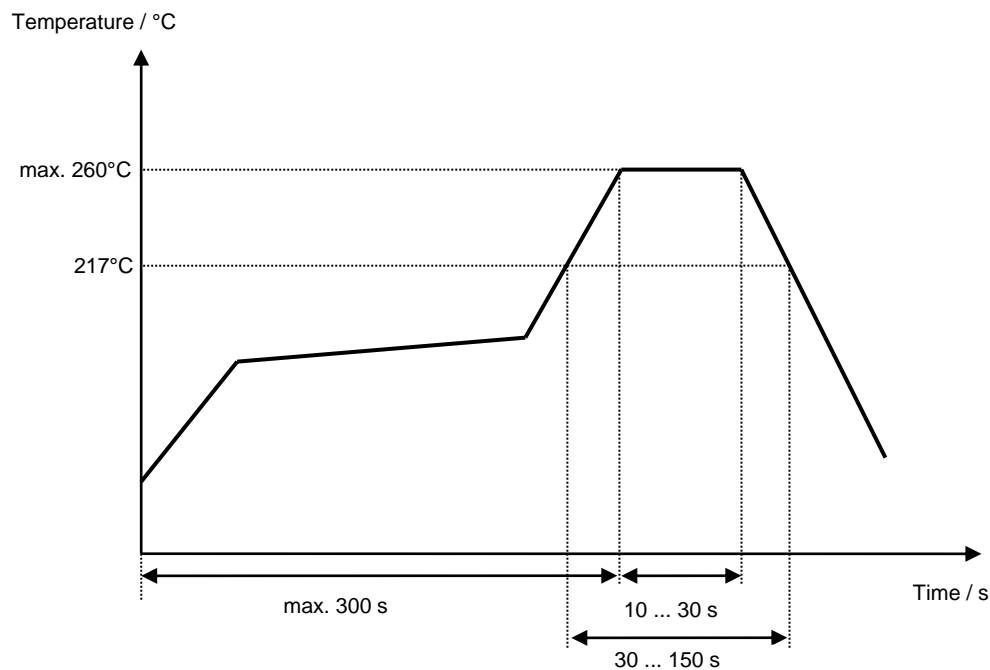
The minimum bending radius is 45 mm.

Microchip Frequency Technology GmbH
Potsdamer Straße 18
D 14 513 TELTOW / Germany
Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30

Microchip Frequency Technology GmbH reserves the right to make changes to the product(s) and/or information contained herein without notice. No liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such product(s) or information.

Air reflow temperature conditions

Conditions	Exposure
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile

Microchip**Filter specification****TFS 130B****5/5****History**

Version	Reason of Changes	Name	Date
1.0	- Generation of filter specification	Strehl	07.09.2005
1.1	- operating temperature range extended - stability characteristics modified	Pfeiffer	10.01.2006
1.2	- pin connections: typing error corrected	Pfeiffer	17.01.2008